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Team Nexperia



# 20 V, 4.3 A NPN low V<sub>CEsat</sub> (BISS) transistor Rev. 01 — 31 January 2010

**Product data sheet** 

#### 1. **Product profile**

### **1.1 General description**

NPN low V<sub>CEsat</sub> Breakthrough In Small Signal (BISS) transistor in a SOT23 (TO-236AB) small Surface-Mounted Device (SMD) plastic package.

PNP complement: PBSS4021PT.

### 1.2 Features

- Very low collector-emitter saturation voltage V<sub>CEsat</sub>
- High collector current capability I<sub>C</sub> and I<sub>CM</sub>
- High collector current gain (h<sub>FE</sub>) at high I<sub>C</sub>
- High energy efficiency due to less heat generation
- AEC-Q101 qualified
- Smaller required Printed-Circuit Board (PCB) area than for conventional transistors

### 1.3 Applications

- Loadswitch
- Battery-driven devices
- Power management
- Charging circuits
- Power switches (e.g. motors, fans)

### 1.4 Quick reference data

#### Table 1. **Quick reference data**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CEO}$	collector-emitter voltage	open base	-	-	20	V
I <sub>C</sub>	collector current		-	-	4.3	А
I <sub>CM</sub>	peak collector current	single pulse; $t_p \leq 1 \text{ ms}$	-	-	8	A
R <sub>CEsat</sub>	collector-emitter saturation resistance	I <sub>C</sub> = 4 A; I <sub>B</sub> = 400 mA	<u>[1]</u> -	36	50	mΩ

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20 V, 4.3 A NPN low V<sub>CEsat</sub> (BISS) transistor

### 2. Pinning information

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	base		
2	emitter		3
3	collector		
			sym021

### 3. Ordering information

Table 3. Orde	ering inform	nation	
Type number	Package		
	Name	Description	Version
PBSS4021NT	-	plastic surface-mounted package; 3 leads	SOT23

### 4. Marking

Table 4.         Marking codes	
Type number	Marking code <sup>[1]</sup>
PBSS4021NT	*BH
[1] * = -: made in Hong Kong	

\* = p: made in Hong Kong

- \* = t: made in Malaysia
- \* = W: made in China

### 5. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CBO</sub>	collector-base voltage	open emitter	-	20	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	20	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	5	V
I <sub>C</sub>	collector current		-	4.3	А
I <sub>CM</sub>	peak collector current	single pulse; $t_p \leq 1 ms$	-	8	А
I <sub>B</sub>	base current		-	1	А

#### 20 V, 4.3 A NPN low $V_{CEsat}$ (BISS) transistor

Table 5.	Limiting	values	continued
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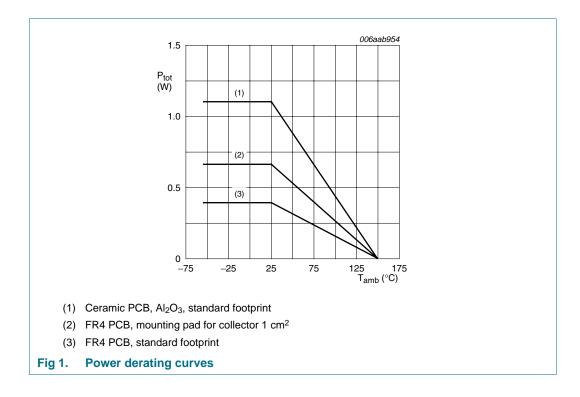
In accordance with the Absolute Maximum Rating System (IEC 60134).

		0, 1	,		
Symbol	Parameter	Conditions	Min	Max	Unit
P <sub>tot</sub>	total power dissipation	$T_{amb} \leq 25 ~^{\circ}C$	<u>[1]</u> -	390	mW
			[2] _	660	mW
			<u>[3]</u> _	1100	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-55	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

[3] Device mounted on a ceramic PCB,  $AI_2O_3$ , standard footprint.



20 V, 4.3 A NPN low V<sub>CEsat</sub> (BISS) transistor

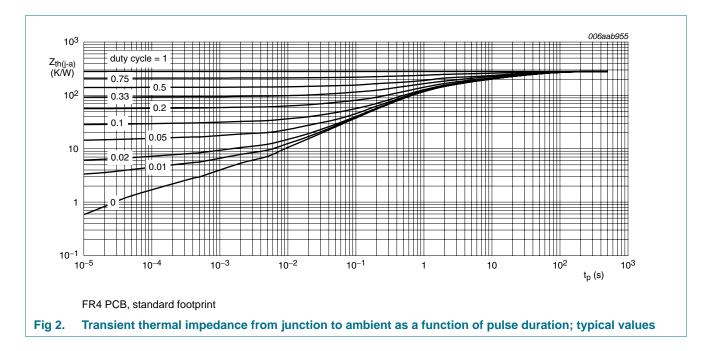
### 6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-a)</sub> thermal resistance from junction to ambient	thermal resistance from	in free air	<u>[1]</u> -	-	320	K/W
	junction to ambient		[2] _	-	190	K/W
			<u>[3]</u> _	-	115	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		-	-	62	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

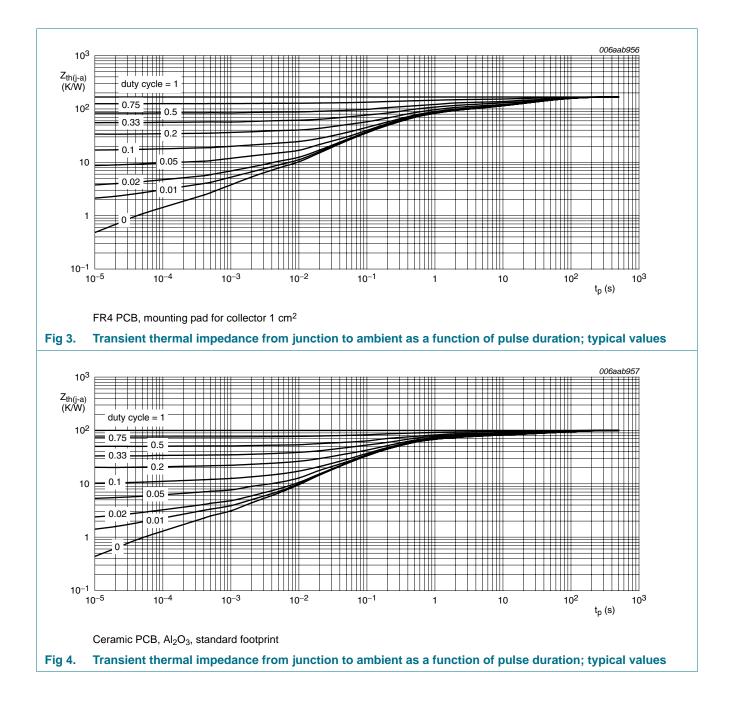
[3] Device mounted on a ceramic PCB,  $AI_2O_3$ , standard footprint.



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# PBSS4021NT

#### 20 V, 4.3 A NPN low V<sub>CEsat</sub> (BISS) transistor



PBSS4021NT 1

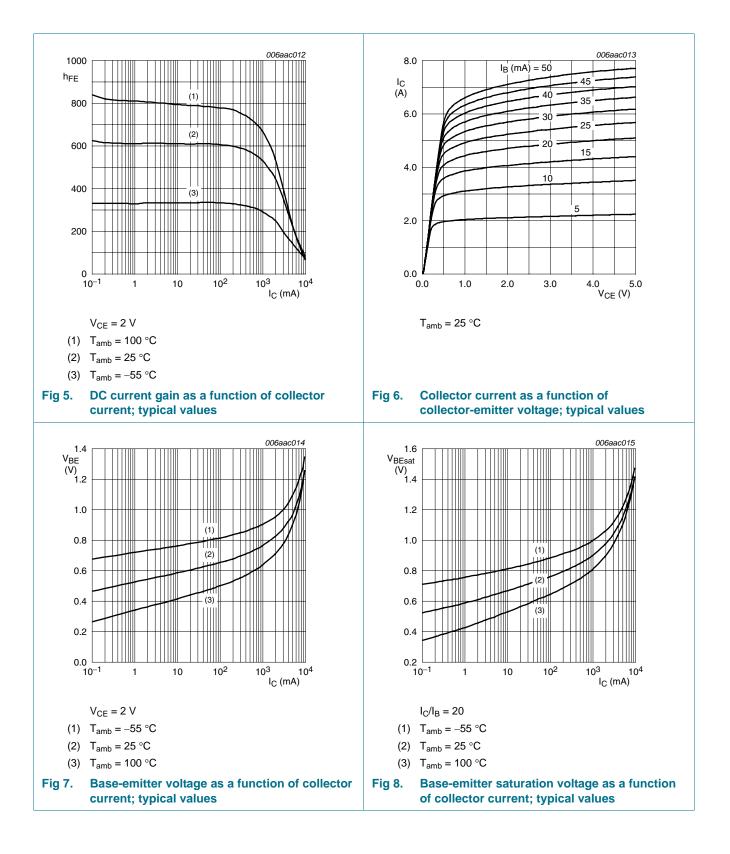
20 V, 4.3 A NPN low V<sub>CEsat</sub> (BISS) transistor

### 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>CBO</sub>	collector-base cut-off	$V_{CB} = 20 \text{ V}; \text{ I}_{E} = 0 \text{ A}$		-	-	100	nA
	current	$V_{CB} = 20 \text{ V}; I_E = 0 \text{ A};$ T <sub>j</sub> = 150 °C		-	-	50	μΑ
I <sub>CES</sub>	collector-emitter cut-off current	$V_{CE} = 16 \text{ V};  V_{BE} = 0 \text{ V}$		-	-	100	nA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; \text{ I}_{C} = 0 \text{ A}$		-	-	100	nA
h <sub>FE</sub>	DC current gain	$V_{CE} = 2 \text{ V}; I_{C} = 500 \text{ mA}$		300	550	-	
		$V_{CE} = 2 \text{ V}; \text{ I}_{C} = 1 \text{ A}$	[1]	300	500	-	
		$V_{CE} = 2 \text{ V}; \text{ I}_{C} = 2 \text{ A}$	[1]	300	420	-	
		$V_{CE} = 2 V; I_C = 4 A$	[1]	150	260	-	
		$V_{CE} = 2 V; I_C = 6 A$	[1]	100	170	-	
V <sub>CEsat</sub>	collector-emitter		[1]				
	saturation voltage	I <sub>C</sub> = 1 A; I <sub>B</sub> = 50 mA		-	42	60	mV
		I <sub>C</sub> = 1 A; I <sub>B</sub> = 10 mA		-	55	75	mV
		$I_{C} = 2 \text{ A}; I_{B} = 40 \text{ mA}$		-	85	120	mV
	$I_{C} = 4 \text{ A}; I_{B} = 200 \text{ mA}$		-	155	220	mV	
		$I_{C} = 4 \text{ A}; I_{B} = 40 \text{ mA}$		-	190	265	mV
		$I_{C} = 4 \text{ A}; I_{B} = 400 \text{ mA}$		-	145	200	mV
R <sub>CEsat</sub>	collector-emitter saturation resistance	$I_{C} = 4 \text{ A}; I_{B} = 400 \text{ mA}$	<u>[1]</u>	-	36	55	mΩ
V <sub>BEsat</sub>	base-emitter	I <sub>C</sub> = 1 A; I <sub>B</sub> = 100 mA	[1]	-	0.94	1.05	V
	saturation voltage	I <sub>C</sub> = 4 A; I <sub>B</sub> = 400 mA	[1]	-	1.17	1.25	V
V <sub>BEon</sub>	base-emitter turn-on voltage	$V_{CE} = 2 \text{ V}; I_{C} = 2 \text{ A}$		-	0.81	0.9	V
t <sub>d</sub>	delay time	$V_{CC}$ = 12.5 V; I <sub>C</sub> = 1 A;		-	15	-	ns
t <sub>r</sub>	rise time	$I_{Bon} = 0.05 \text{ A};$		-	45	-	ns
t <sub>on</sub>	turn-on time	$I_{Boff} = -0.05 \text{ A}$		-	60	-	ns
t <sub>s</sub>	storage time			-	490	-	ns
t <sub>f</sub>	fall time			-	80	-	ns
t <sub>off</sub>	turn-off time			-	570	-	ns
f <sub>T</sub>	transition frequency	V <sub>CE</sub> = 10 V; I <sub>C</sub> = 100 mA; f = 100 MHz		-	165	-	MHz
C <sub>c</sub>	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz		-	36	-	pF

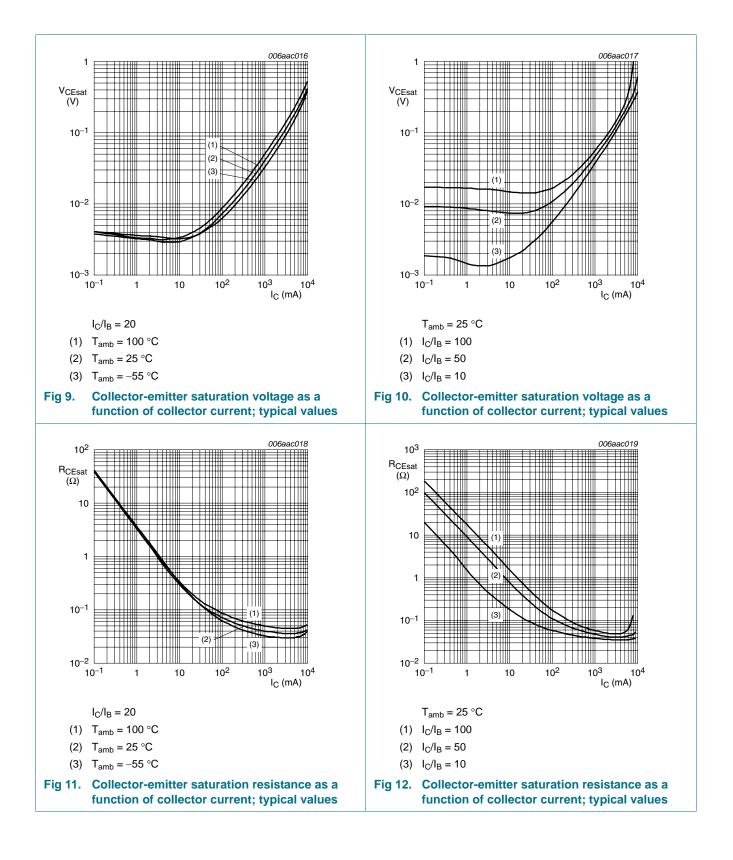
 $\label{eq:point} \begin{tabular}{ll} \mbox{Pulse test: } t_p \leq 300 \ \mu \mbox{s; } \delta \leq 0.02. \end{tabular}$ 

#### 20 V, 4.3 A NPN low V<sub>CEsat</sub> (BISS) transistor



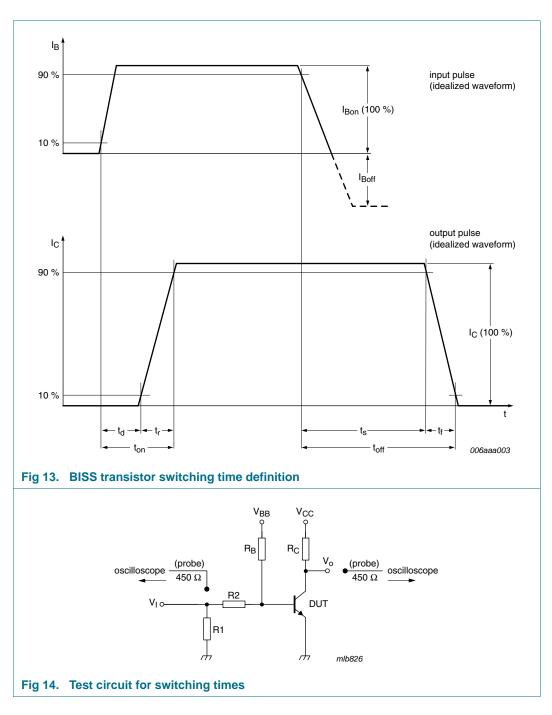
PBSS4021NT\_1

#### 20 V, 4.3 A NPN low V<sub>CEsat</sub> (BISS) transistor



20 V, 4.3 A NPN low V<sub>CEsat</sub> (BISS) transistor

### 8. Test information

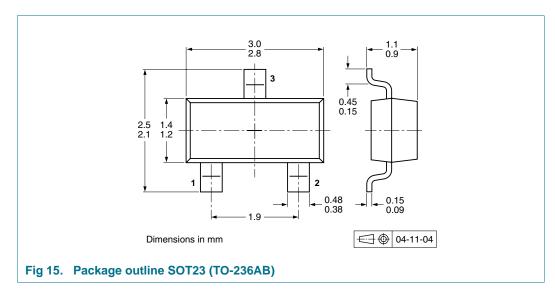


### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

20 V, 4.3 A NPN low V<sub>CEsat</sub> (BISS) transistor

### 9. Package outline



### **10. Packing information**

#### Table 8. Packing methods

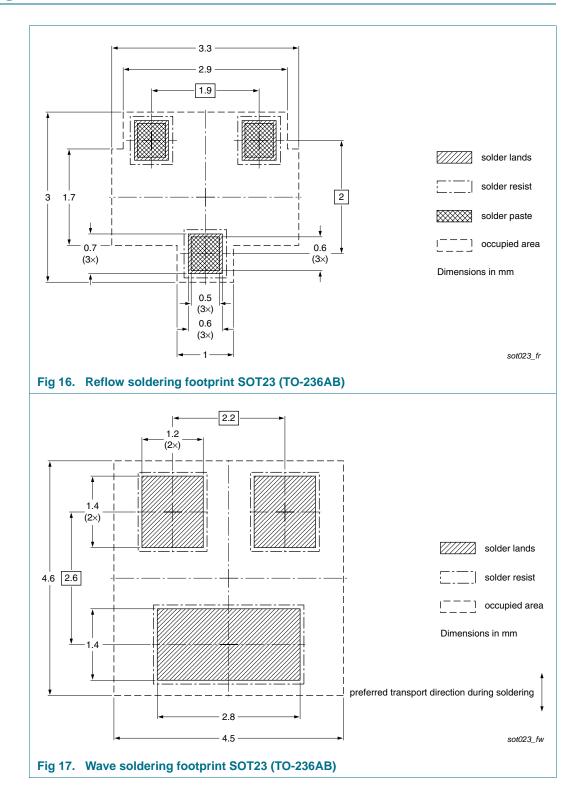
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	cription Packing quantity		quantity
				3000	10000
PBSS4021NT	SOT23	4 mm pitch, 8 mm tape and reel		-215	-235

[1] For further information and the availability of packing methods, see <u>Section 14</u>.

#### 20 V, 4.3 A NPN low V<sub>CEsat</sub> (BISS) transistor

### 11. Soldering



### 20 V, 4.3 A NPN low V<sub>CEsat</sub> (BISS) transistor

### **12. Revision history**

Table 9. Revision hi	istory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PBSS4021NT_1	20100131	Product data sheet	-	-

#### 20 V, 4.3 A NPN low V<sub>CEsat</sub> (BISS) transistor

### 13. Legal information

### 13.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Product data sheet

#### 20 V, 4.3 A NPN low V<sub>CEsat</sub> (BISS) transistor

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Date of release: 31 January 2010 Document identifier: PBSS4021NT\_1

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